

SCOPE OF ACCREDITATION

Electronics - Printed Board Assemblies

Zollner Electronic (Taicang) Co., Ltd.
Ningbo East Road No. 29
Taicang, JIANGSU 215400
China

This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7000 Rev A - AUDIT CRITERIA FOR NADCAP ACCREDITATION

AC7120 Rev E - Nadcap Audit Criteria for Printed Board Assemblies (to be used on audits on/after 9 April 2017) (CANNOT BE COMBINED WITH AC7119 or AC7121)

In-Process Verification / Inspection: AOI
In-Process Verification / Inspection: X-Ray
Kitting
Moisture Sensitive Components and Materials

AC7120/2 - General Soldering of Printed Board Assemblies (to be used on audits on/after 9 April 2017)

Electronic Component Preparation for Preassembly Process
Gold Removal
Hand Soldering
Part Placement: Manual

AC7120/3 - Plated Through Hole Technology (requires AC7120/2) (to be used on audits on/after 9 April 2017)

Wave Soldering

AC7120/4 Rev A - Surface Mount Technology (requires AC7120/2) (to be used on audits on/after 3 March 2019)

Preparation
Solder Paste Printing: Stencil Printing

AC7120/6 - Lead Free Soldering (requires AC7120/2) (to be used on audits on/after 9 April 2017)

AC7120/7 Rev A - Conformal Coating of Printed Board Assemblies (to be used on audits on/AFTER 05-Nov-2023)

AC7120/10 - Final Testing (to be used on audits on/after 9 April 2017)

AC7120/12 - Nadcap Audit Criteria for Depaneling (to be used on audits on/after 30 June 2019)

Mechanical Router Process

Programming